

**DECLARATION - USA PATENT APPLICATION**

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name;

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled **SYSTEM AND METHOD FOR MEASURING PROPERTIES OF A SEMICONDUCTOR SUBSTRATE IN A NON-DESTRUCTIVE WAY** the specification of which was filed on July 16, 2003 as Application No. 10/622,084.

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above;

I acknowledge the duty to disclose information which is material to the patentability of this application in accordance with Title 37, Code of Federal Regulations, § 1.56;

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application(s) for patent, design or inventor's certificate or any PCT international application(s) listed below and have also identified below any foreign application(s) for patent, design or inventor's certificate or any PCT international application(s) designating at least one country other than the United States of America filed for the same subject matter having a filing date before that of the application(s) of which priority is claimed:

**PRIOR FOREIGN APPLICATION(S)**

COUNTRY (OR INDICATE IF PCT)	APPLICATION NUMBER	DATE OF FILING (day, month, year)	PRIORITY CLAIMED UNDER 35 U.S.C. § 119
			<input type="checkbox"/> YES      NO <input type="checkbox"/>
			<input type="checkbox"/> YES      NO <input type="checkbox"/>

I hereby claim the benefit under Title 35, United States Code, § 119 of any United States application(s) listed below, and insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code § 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, § 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

**Prior U.S.A. Provisional Application(s)**

Application No.: 60/397,566      Filing Date: July 19, 2002

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful, false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of first inventor: **Trudo Clarysse**

Inventor's signature  Day 27 Month 10 Year 2003

Residence (city and country): **2020 Antwerpen, Belgium**

Citizenship: **Belgian**

Post Office Address: **Pestalozzistraat 3, 2020 Antwerpen, Belgium**

Full name of second inventor: **Wilfried Vandervorst**

Inventor's signature  Day 18 Month 05 Year 2003

Residence (city and country): **2800 Mechelen, Belgium**

Citizenship: **Belgian**

Post Office Address: **Stuivenberglaan 106, 2800 Mechelen, Belgium**

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Send Correspondence To:

KNOBBE, MARTENS, OLSON & BEAR, LLP  
Customer No. 20,995